

Absolute Maximum Rating

| Rating | Symbol | Value | Units |
|--|------------------|------------------|-------|
| ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹ | V _{ESD} | +/- 20 +/- 15 | kV |
| Junction Temperature | T, | 125 | °C |
| Operating Temperature | T _{op} | -40 to +85 | °C |
| Storage Temperature | T _{STG} | -55 to +150 | °C |

Notes

1)Measured with a 20dB attenuator, 50 Ohm scope input impedance, 2GHz bandwidth. ESD gun return path connected to ESD ground plane.

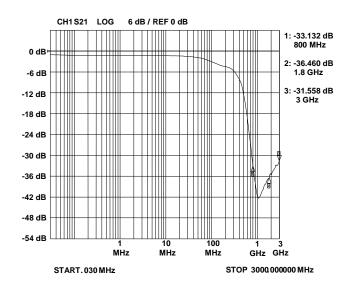
Electrical Characteristics (T=25°C)

| Parameter | Symbol | Conditions | Minimum | Typical | Maximum | Units | |
|--|---|--|---------|---------|---------|-------|--|
| Reverse Stand-Off Voltage | V _{RWM} | Any I/O to GND | | | 5 | V | |
| Reverse Breakdown Voltage | V_{BR} | I _t = 1mA, Any I/O to GND | 6 | 8 | 10 | V | |
| Reverse Leakage Current | I _R | V _{RWM} = 5.0V, Any I/O to GND | | | 0.100 | μΑ | |
| DC Resistance R _{DC} Each Channel, Between Input and Output | | Each Channel, Between Input and Output | | 18 | | Ohms | |
| Filter Cut-Off Frequency | f _c | $Z_{Source} = Z_{Load} = 50 \text{ Ohms}$ | | 150 | | MHz | |
| Inductance | L | | | 19 | | nH | |
| Total Series Inductance | L ₁ + L ₂ | Each Channel, Between Input and Output | | 38 | | nH | |
| Capacitance | C ₁ , C ₂ , C ₃ | V _R = 2.5V, f = 1MHz | 10 | 12 | 15 | pF | |
| Total Capacitance | C ₁ + C _{2 +} C ₃ | V _R = 2.5V, f = 1MHz, Each Channel Input to GND | 30 | 36 | 45 | pF | |

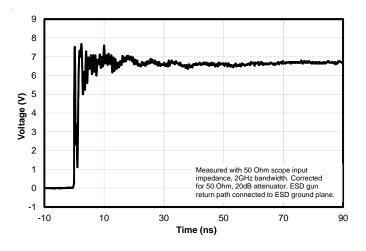


Typical Characteristics

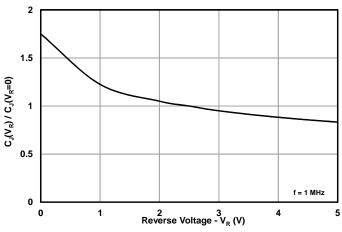
Typical Insertion Loss S21 (Each Line)



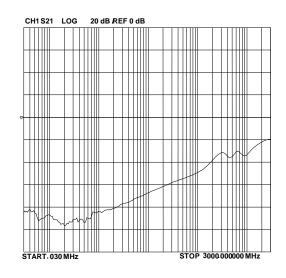
ESD Clamping (+8kV Contact per IEC 61000-4-2) Each Channel to GND



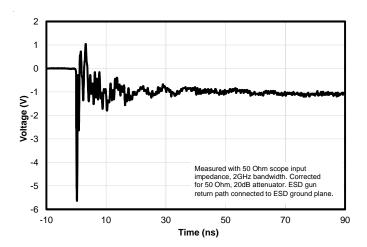
Capacitance vs. Reverse Voltage (Normalized to 2.5 volts)



Analog Crosstalk (Each Line)



ESD Clamping (-8kV Contact per IEC 61000-4-2) Each Channel to GND



Downloaded from Arrow.com.



Applications Information

Device Connection

The EClamp2398P is comprised of eight identical circuits each consisting of a low pass filter for EMI/RFI suppression and dual TVS diodes for ESD protection. The device is in a 16-pin SLP package. Electrical connection is made to the 16 pins located at the bottom of the device. A center tab serves as the ground connection. The device has a flow through design for easy layout. Pin connections are noted in Figure 1. All path lengths should be kept as short as possible to minimize the effects of parasitic inductance in the board traces. Recommendations for the ground connection are given below.

Ground Connection Recommendation

Parasitic inductance present in the board layout will affect the filtering performance of the device. As frequency increases, the effect of the inductance becomes more dominant. This effect is given by Equation 1.

Equation 1: The Impedance of an Inductor at Frequency XLF

$$XLF(L, f) = 2 * \pi * f * L$$

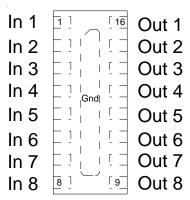
Where:

L= Inductance (H)

f = Frequency (Hz)

Via connections to the ground plane form rectangular wire loops or ground loop inductance as shown in Figure 2. Ground loop inductance can be reduced by using multiple vias to make the connection to the ground plane. Bringing the ground plane closer to the signal layer (preferably the next layer) also reduces ground loop inductance. Multiple vias in the device ground pad will result in a lower inductive ground loop over two exterior vias. Vias with a diameter d are separated by a distance y run between layers separated by a distance x. The inductance of the loop path is given by Equation 2. Thus, decreasing distance x and y will reduce the loop inductance and result in better high frequency filter characteristics.

Figure 1 - Pin Identification and Configuration (Top Side View)



| Pin | Identification |
|------------|----------------|
| 1 - 8 | Input Lines |
| 9 - 16 | Output Lines |
| Center Tab | Ground |

Figure 2 - Inductance of Rectangular Wire Loops

Equation 2: Inductance of Rectangular Wire Loop

LRECT(d, x, y) =
$$10.16 * 10^{-9} * \left[x * \ln \left[\frac{2*y}{d} \right] + y * \ln \left[\frac{2*x}{d} \right] \right]$$

Where:

d = Diameter of the wire (in)

x = Length of wire loop (in)

y = Breath of wire loop (in)



Applications Information

Figure 3 shows the recommended device layout. The ground pad vias have a diameter of 0.008 inches (0.20 mm) while the two external vias have a diameter of 0.010 inches (0.250mm). The internal vias are spaced approximately evenly from the center of the pad. The designer may choose to use more vias with a smaller diameter (such as 0.005 inches or 0.125mm) since changing the diameter of the via will result in little change in inductance (i.e. the log function in Equation 2 in highly insensitive to parameter d) . Figure 4 shows a typical insertion loss (S21) plot for the device using Semtech's filter evaluation board with 50 0hm traces and the recommended via configuration.

Figure 3 - Recommended Layout Using Ground Vias

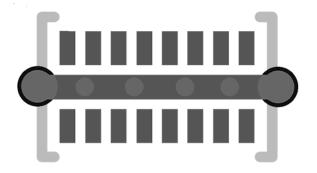
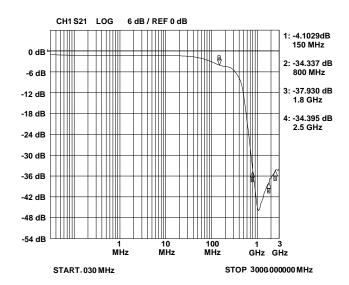
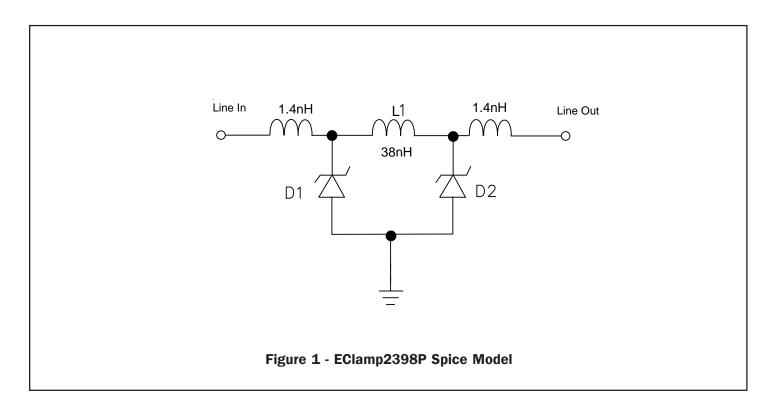


Figure 4 - Filter Characteristics Using Recommended Layout with Internal Vias





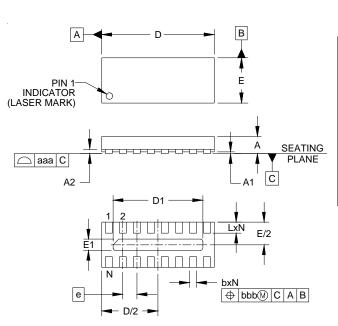
Applications Information - Spice Model



| Table 1 - EClamp2398P Spice Parameters | | | | | | | | |
|--|-------|----------|----------|--|--|--|--|--|
| Parameter | Unit | D1 (TVS) | D2 (TVS) | | | | | |
| IS | Amp | 4.09E-15 | 4.09E-15 | | | | | |
| BV | Volt | 7.435 | 7.435 | | | | | |
| ٧J | Volt | 0.743 | 0.743 | | | | | |
| RS | Ohm | 0.584 | 0.584 | | | | | |
| IBV | Amp | 1E-3 | 1E-3 | | | | | |
| C10 | Farad | 31.3E-12 | 31.3E-12 | | | | | |
| TT | sec | 2.541E-9 | 2.541E-9 | | | | | |
| М | | 0.23 | 0.23 | | | | | |
| N | | 1.1 | 1.1 | | | | | |
| EG | eV | 1.11 | 1.11 | | | | | |



Outline Drawing - SLP4014P16

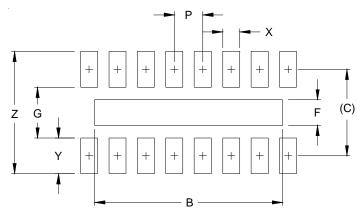


| DIMENSIONS | | | | | | | | |
|------------|------|--------|------|----------|--------|------|--|--|
| | | | | | | | | |
| DIM | 11 | NCHE | S | MILL | IMET | ERS | | |
| ווועו | MIN | NOM | MAX | MIN | NOM | MAX | | |
| Α | .020 | .023 | .026 | 0.50 | 0.58 | 0.65 | | |
| A1 | .000 | .001 | .002 | 0.00 | .003 | 0.05 | | |
| A2 | | (.005) | | | (0.13) | | | |
| q | .007 | .010 | .012 | 0.20 | 0.25 | 0.30 | | |
| D | .153 | .157 | .161 | 3.90 | 4.00 | 4.10 | | |
| D1 | .122 | .126 | .130 | 3.10 | 3.20 | 3.30 | | |
| Е | .059 | .063 | .067 | 1.50 | 1.60 | 1.70 | | |
| E1 | .010 | .016 | .020 | 0.25 | 0.40 | 0.50 | | |
| е | .0 | 20 BS | SC | 0.50 BSC | | | | |
| L | .011 | .013 | .015 | 0.28 | 0.33 | 0.38 | | |
| Ν | | 16 | | 16 | | | | |
| aaa | | .003 | | 0.08 | | | | |
| bbb | | .004 | | 0.10 | | | | |

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Land Pattern - SLP4014P16



| | DIMENSIONS | | | | | | | | |
|-----|------------|-------------|--|--|--|--|--|--|--|
| DIM | INCHES | MILLIMETERS | | | | | | | |
| В | .130 | 3.30 | | | | | | | |
| С | .060 | 1.52 | | | | | | | |
| F | .018 | 0.45 | | | | | | | |
| G | .035 | 0.89 | | | | | | | |
| Р | .020 | 0.50 | | | | | | | |
| Χ | .012 | 0.30 | | | | | | | |
| Υ | .025 | 0.63 | | | | | | | |
| Ζ | .085 | 2.15 | | | | | | | |

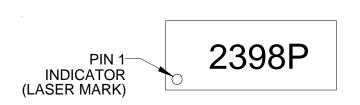
NOTES

1. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



Marking Codes

Ordering Information



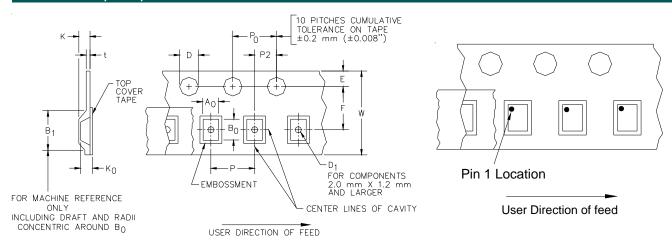
| Part Number | Qty per Reel | Reel Size | | |
|-----------------|-----------------|-----------|--|--|
| EClamp2398P.TCT | 3000 | 7 Inch | | |

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Carrier Tape Specification

B0

K0



Device Orientation in Tape

| 1.78 +/- | -0.10 mm | 4.30 +/-0.10 | mm (| 0.74 +/-0.10 mm | | | | | | | |
|---------------|------------------|---|---------------------------|--------------------------------|-------------------------------|------------------|-----------------------------------|-----------------------------------|--------------------------------|------------------|--|
| Tape Width | B, (Max) | D | D1 | E | F | K (MAX) | Р | PO | P2 | T(MAX) | W |
| 12 mm | 8.2 mm (.476) | 1.5 + 0.1 mm - 0.0 mm (0.59 +.005 000) | 1.0 mm ±0.05 (.039) | 1.750±.10 mm (.069±.004) | 5.5±0.05 mm (.217±.002) | 4.5 mm (.177) | 4.0±0.1 mm (.157±.00- 4) | 4.0±0.1 mm (.157±.00- 4) | 2.0±0.05m- m (.079±.002) | 0.4 mm (.016) | 12.0 mm + 0.3 mm - 0.1 mm (.472±.012) |

Contact Information

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